

Title (en)  
Electrotechnical component

Title (de)  
Elektrotechnisches Bauteil

Title (fr)  
Composant électrotechnique

Publication  
**EP 1571735 A3 20060329 (DE)**

Application  
**EP 05000891 A 20050118**

Priority  
DE 102004011358 A 20040305

Abstract (en)  
[origin: EP1571735A2] Electronic component, especially for telecommunications and/or data transfer systems, comprises a primary installation board (1) which is rigid, and secondary installation board (2) which is a conducting board and flexible. The secondary board has a primary end (3) which is fixed to the primary board. The secondary end (4) is attached to the primary installation board. A parallel conductor section (5) connects the two end sections.

IPC 8 full level  
**H01R 13/66** (2006.01); **H01R 12/14** (2006.01); **H01R 12/62** (2011.01); **H01R 24/00** (2006.01); **H04M 1/02** (2006.01)

IPC 8 main group level  
**H02K** (2006.01)

CPC (source: EP)  
**H01R 12/62** (2013.01); **H01R 24/64** (2013.01)

Citation (search report)

- [X] US 4720269 A 19880119 - HASKINS STEVE W [US], et al
- [X] US 5967854 A 19991019 - CRAIG PETER [CA]

Cited by  
JP2013009505A; JP2013009504A; EP2983255A1; WO2009074197A3; WO2007144156A1; WO2008095522A1; US8083551B2; US8435083B2

Designated contracting state (EPC)  
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IS IT LI LT LU MC NL PL PT RO SE SI SK TR

DOCDB simple family (publication)  
**EP 1571735 A2 20050907; EP 1571735 A3 20060329; EP 1571735 B1 20101006**; AT E484091 T1 20101015; DE 102004011358 A1 20051103; DE 102004011358 B4 20070104; DE 502005010326 D1 20101118; NO 20050339 D0 20050121; NO 20050339 L 20050906; NO 328861 B1 20100531

DOCDB simple family (application)  
**EP 05000891 A 20050118**; AT 05000891 T 20050118; DE 102004011358 A 20040305; DE 502005010326 T 20050118; NO 20050339 A 20050121